TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74HC4094AP, TC74HC4094AF**

8-Bit Shift and Store Register (3-state)

The TC74HC4094A is a high speed CMOS 8-BIT SHIFT AND STROBE REGISTER fabricated with silicon gate  $\rm C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

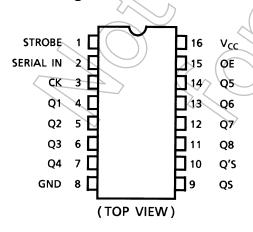
It consists of an 8-bit shift register and an 8-bit latch with 3-state output buffers. Data is shifted serially though the shift register on the positive going transition of the CK input. The output of the last stage (Qs) can be used to cascade several devices. Data on the Qs output is transferred to a second output (Q's) on the following negative transition of the CK input. The data in each stage of the shift register is provided to a corresponding latch, on the negative going transition of the STROBE input. When STROBE is held high, data propagates through the latch to a 3-state output buffer. This buffer is enabled when OUTPUT ENABLE input is set high.

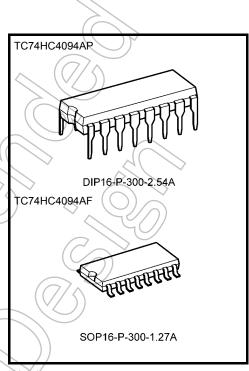
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $f_{max} = 73 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation: I<sub>CC</sub> = 4 μA (max) at Ta = 25°C
- High noise immunity:  $V_{NIH} = V_{NIL} = 28\% V_{CC}$  (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: |IOH| = IOL = 4 mA (min)
- Balanced propagation delays: tpLH = tpHL
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 4094B

#### Pin Assignment



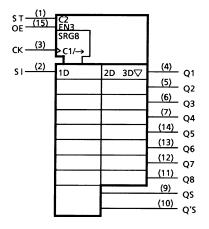


Weight

DIP16-P-300-2.54A SOP16-P-300-1.27A : 1.00 g (typ.) : 0.18 g (typ.)

Start of commercial production 1986-05

# **IEC Logic Symbol**



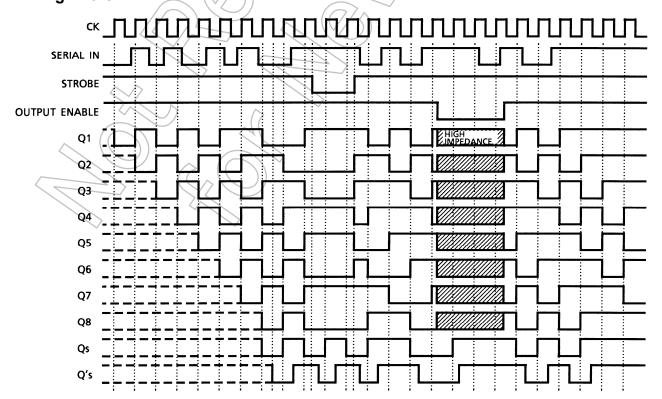
#### **Truth Table**

СКС	OE	ST	SI	Pa	ra. Out	Seri. Out		
CK	CK OL 31 31		31	Q1	Qn	Qs	Q's	
	Н	Н	L	L	Qn – 1	Q7	NC	
	Н	Н	Н	Н	Qn – 1	Q7	Ŋ¢ (	
	Н	L	*	NC	NC	Q7	NC	
	L	*	*	Z	Z	Q7	NC	
	Н	*	*	NC	NC	NO	Qs	
	L	*	*	Z	Z	NC	Qs	

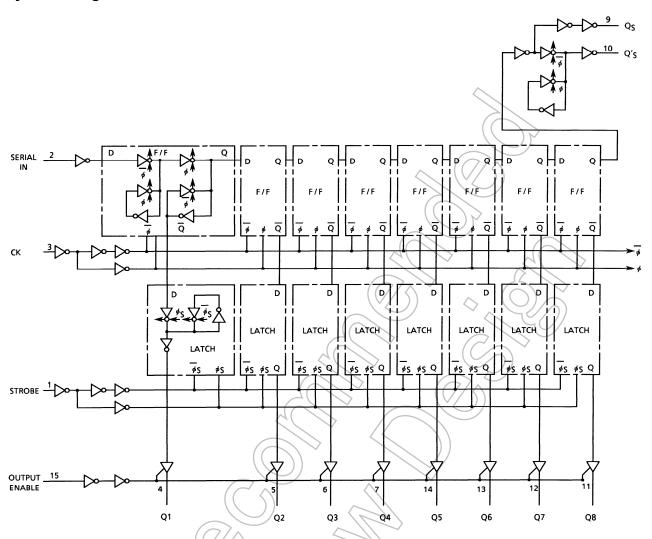
X: Don't care

NC: No change Z: High impedance

#### **Timing Chart**



#### **System Diagram**



#### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	Vce	–0.5 to 7	V
DC input voltage	V <sub>IN</sub>	−0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	<b>J</b> IK	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V <sub>CC</sub> /ground current	tce	±50	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta =  $-40 \text{ to } 65^{\circ}\text{C}$ . From Ta =  $65 \text{ to } 85^{\circ}\text{C}$  a derating factor of  $-10 \text{ mW}/^{\circ}\text{C}$  shall be applied until 300 mW.



# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	()

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.

#### **Electrical Characteristics**

#### **DC Characteristics**

					$\mathcal{I}$ .		~ (	. // Ta	a  =		
Characteristics	Symbol	Test Condition				Га = 25°C		+40 to 85°C		Unit	
	•			V <sub>CC</sub> (V)	Min	Typ.	Max	Min	Max		
				2.0	1.50	_	/)	1.50	_		
High-level input voltage	$V_{IH}$		-	4.5	3.15	7/	$\sim$	3.15	_	V	
				6.0	4.20	$\langle \langle \rangle$	) —	4.20	_		
			4/1	2.0//	_	\ <u> </u>	0.50	_	0.50		
Low-level input voltage	$V_{IL}$			4.5	_	) )—	1.35	_	1.35	V	
			$\bigcirc)$	6.0	-	/_	1.80	_	1.80		
	Voн	VIN OF VIL		2.0	1.9	2.0		1.9	_		
			I <sub>OH</sub> = -20 μA	4.5	4.4	4.5	_	4.4	_		
High-level output voltage			VIN = VIH or VII	4	6.0	5.9	6.0		5.9	_	V
			I <sub>OH</sub> = -4 mA	4.5	4.18	4.31	_	4.13	_		
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	_	5.63	_		
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	11/6	2.0	_	0.0	0.1	_	0.1		
			$I_{OL} = 20 \mu A$	4.5	_	0.0	0.1	_	0.1		
Low-level output voltage				6.0	_	0.0	0.1	_	0.1	V	
\		^	$I_{OL} = 4 \text{ mA}$	4.5	_	0.17	0.26	_	0.33		
		$\mathcal{A}($	$I_{OL} = 5.2 \text{ mA}$	6.0	_	0.18	0.26	_	0.33		
3-state output off-state current	loz	$V_{IN} = V_{IH}$ or $V_{OUT} = V_{CC}$		6.0			±0.5		±5.0	μΑ	
Input leakage current	I <sub>IN</sub>	$V_{IN} = V_{CC}$ or	GND	6.0	_	_	±0.1	_	±1.0	μΑ	
Quiescent supply current	Icc	V <sub>IN</sub> ⇒ V <sub>CC</sub> or	GND	6.0	_	_	4.0	_	40.0	μΑ	



# Timing Requirements (input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	Test Condition			Ta = -40 to 85°C	Unit
			V <sub>CC</sub> (V)	Тур.	Limit	Limit	
Minimum pulse width	t <sub>W (H)</sub>		2.0	_	75	95	
(CK)	tw (H)	_	4.5		15	19	ns
(Gity	*VV (L)		6.0		13	16	
Minimum pulse width			2.0	(F	75	95	
(STROBE)	t <sub>W (H)</sub>	_	4.5	,>>	15	19	ns
(611(652)		<	6.0	( )	13	16	
Minimum set-up time			2.0		75	95	
(SERIAL)	$t_{s}$	_	4.5	· —	15	19	ns
(OEI (II IE)		6	6.0	_	13_	16	
Minimum set-up time		4	2.0	_	100	125	
(STROBE)	$t_{s}$	-	4.5	- /	20	25	ns
(611(652)		$( \langle / \rangle )$	6.0	-((	)17	21	
Minimum hold time			2.0	(7)	(0)	0	
(SERIAL)	t <sub>h</sub>		4.5	7	>0	0	ns
(OEI (II IE)		4()	6.0	<u>/</u>	0	0	
Minimum hold time			2.0		0	0	
(STROBE)	$t_h$		4.5	) —	0	0	ns
(OTTOBE)		4()	6.0	_	0	0	
			2.0	_	6	5	
Clock frequency	f (		4.5	_	30	24	MHz
			6.0		35	28	

# AC Characteristics ( $C_L = 15 \text{ pF}$ , $V_{CC} = 5 \text{ V}$ , $Ta = 25^{\circ}\text{C}$ , input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	ttlh <	<u> </u>	_	4	8	ns
Propagation delay time	t <sub>pLH</sub>			22	35	ns
(CK-Qn)	t <sub>pHL</sub>			22	3	110
Propagation delay time	tpLH	~		16	25	ns
(CK-QS, Q'S)	t <sub>pHL</sub>	_		10	25	10
Propagation delay time	t <sub>brH</sub>			16	27	ns
(STROBE-Qn)	t <sub>pHL</sub>	_		10	21	113
3-state output enable time	t <sub>pZL</sub>	$R_L = 1 \text{ k}\Omega$		13	25	ns
5-state output enable time	t <sub>pZH</sub>			13	23	110
Maximum clock frequency	f <sub>max</sub>	_	33	73		MHz



# AC Characteristics ( $C_L = 50$ pF, input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit
	.,		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
	tтьн		2.0	_	30	75	_	95	
Output transition time	. =	_	4.5	_	8	15	_	19	ns
	t <sub>THL</sub>		6.0		7	13	_	16	
Propagation delay	tarri		2.0	_	92	200	2	250	
time	t <sub>pLH</sub>	_	4.5	_	26	40	<i>y</i> -	50	ns
(CK-Qn)	t <sub>pHL</sub>		6.0	_	20	34	_	43	
Propagation delay	t <sub>pLH</sub>		2.0		65	150	_	190	
time	t <sub>pHL</sub>	_	4.5	-(	19	30	_	38	ns
(CK-QS, Q'S)	·ρι ι∟		6.0		15	26	_	32	
Propagation delay	t <sub>pLH</sub>		2.0	(-)	75	160		200	
time	t <sub>pHL</sub>	_	4.5		20	32	1	40	ns
(STROBE-Qn)	PI IE		6.0		16	27		34	
3-state output enable	$t_{pZL}$		2.0	<i>H</i>	58	150	(4)	190	
time	t <sub>pZH</sub>	$R_L = 1 \text{ k}\Omega$	4.5	_	16	30		38	ns
	<b>F</b>	40	6.0		13((	26	<u> </u>	32	
3-state output disable	$t_{pLZ}$		2.0		35	150	_	190	
time	t <sub>pHZ</sub>	$R_L = 1 \text{ k}\Omega$	4.5	_	16/	30	_	38	ns
	ρ		6.0		13	26	_	32	
Maximum clock			2.0	6	16		5	_	
frequency	f <sub>max</sub>		4.5	30	66		24	_	MHz
			6.0	35	80	_	28	_	
Input capacitance	C <sub>IN</sub>	(		_	5	10	_	10	pF
Bus input capacitance	C <sub>OUT</sub>		(3)	_	10	_	_	_	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)	75) - 6			140	_	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

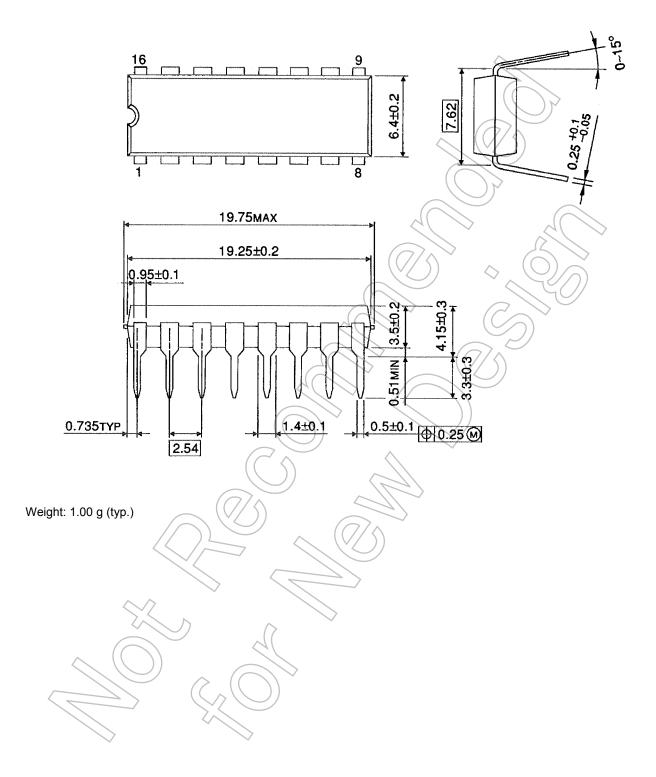
Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 



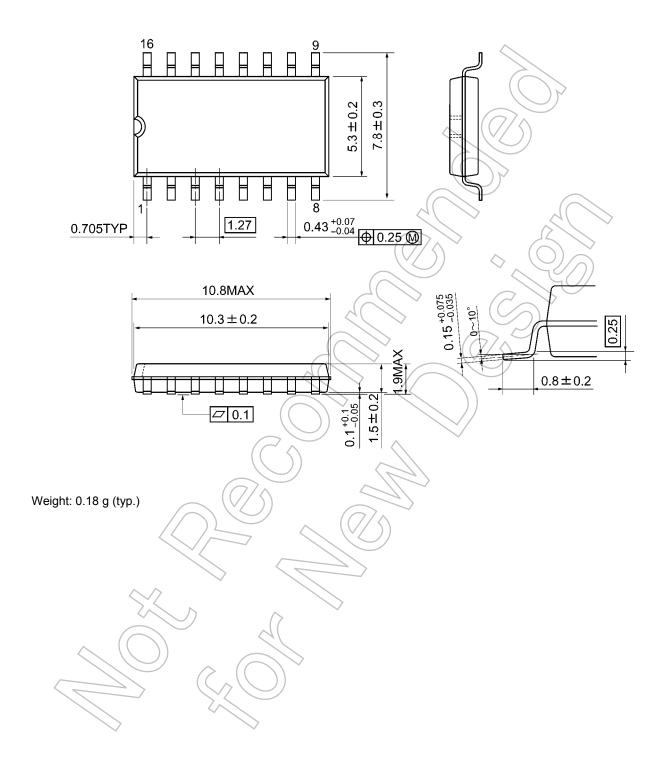
# **Package Dimensions**

DIP16-P-300-2.54A Unit: mm



#### **Package Dimensions**

SOP16-P-300-1.27A Unit: mm



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